



SPECIFICATIONS

DESCRIPTION	HINK-E0215A75
MAKER PART NAME	EPD
MAKER SPECIFICATION	
SOLUM CODE No.	0105A0101077
REMARKS	A2

Gross Weight(kg)	Net Weight(kg)	Unit Weight(g)
3.95	3.08	3

This is to certify that all of parts shipped definitely can meet the requirements of RoHS and
本承认愿将证明给贵司供应的所有部品完全符合RoHS以及HF的要求条件

본 승인원은 귀사에 납품하는 모든 부품에 대해 RoHS 및 Halogen Free (HF) 요구조건을 만족하는 것을 증명합니다.

MADAMS I. D		DATE	2025. 03. 11
DESIGN	CHECK	APPROVAL	
LI NA	LIU WEI	SHI HAO	
2025. 03. 11	2025. 03. 11	2025. 03. 11	

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兴泰盈科

江西兴泰科技股份有限公司
Jiangxi Xingtai Technology Inc.

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Specification for 2.15"EPD

Model NO.: E0215A75

Product VER: A2

Customer Approval

Customer	Solum
Approval By	2021.07.08
Date Of Approval	H/K Lee

It will be agreed by the receiver, if not sign back the Specification within 15days.

Prepared By	Checked By	Approval By
李娜	文海	王浩



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Version	Content	Date	Producer
A0	New release(original model E0215A57)	2024/7/18	Li Na
A1	Add: Vietnam factory, Vietnam sample RA report, and QR code label difference	2024/10/18	Li Na
A2	Add:IC/JD79661CA	2025/3/11	Li Na

Production Place	Vendor(maker) name	Country(area)	Nation
DRIVER IC	Fiti(IC/JD79661AA)	Taiwan	
DRIVER IC	Fiti(IC/JD79661CA)	Taiwan	
Sealant	EUBO	China	
TFT	BOE(FL022CSQ-N52)	China	
FPL	E-ink	Taiwan	
PS	E-ink	Taiwan	



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1. General Description

E0215A75 is an Active Matrix Electrophoretic Display (AMEPD), with interface and a reference system design. The 2.15" active area contains 296×160 pixels, and has B/W/R/Y full display capabilities. An integrated circuit contains gate buffer, source buffer, interface, timing control logic, oscillator, DC-DC, SRAM, LUT, VCOM and border are supplied with each panel.

2. Features

- 296×160 pixels display
- High contrast
- High reflectance
- Ultra wide viewing angle
- Ultra low power consumption
- Pure reflective mode
- Bi-stable display
- Commercial temperature range
- Landscape, portrait modes
- Hard-coat antiglare display surface
- Ultra Low current deep sleep mode
- On chip display RAM
- Low voltage detect for supply voltage
- High voltage ready detect for driving voltage
- Internal temperature sensor
- Waveform stored in On-chip OTP
- Serial peripheral interface available
- On-chip oscillator
- On-chip booster and regulator control for generating VCOM, Gate and Source driving voltage
- I2C signal master interface to read external temperature sensor/ built-in temperature sensor

3. Typical Application

Electronic Shelf Label System

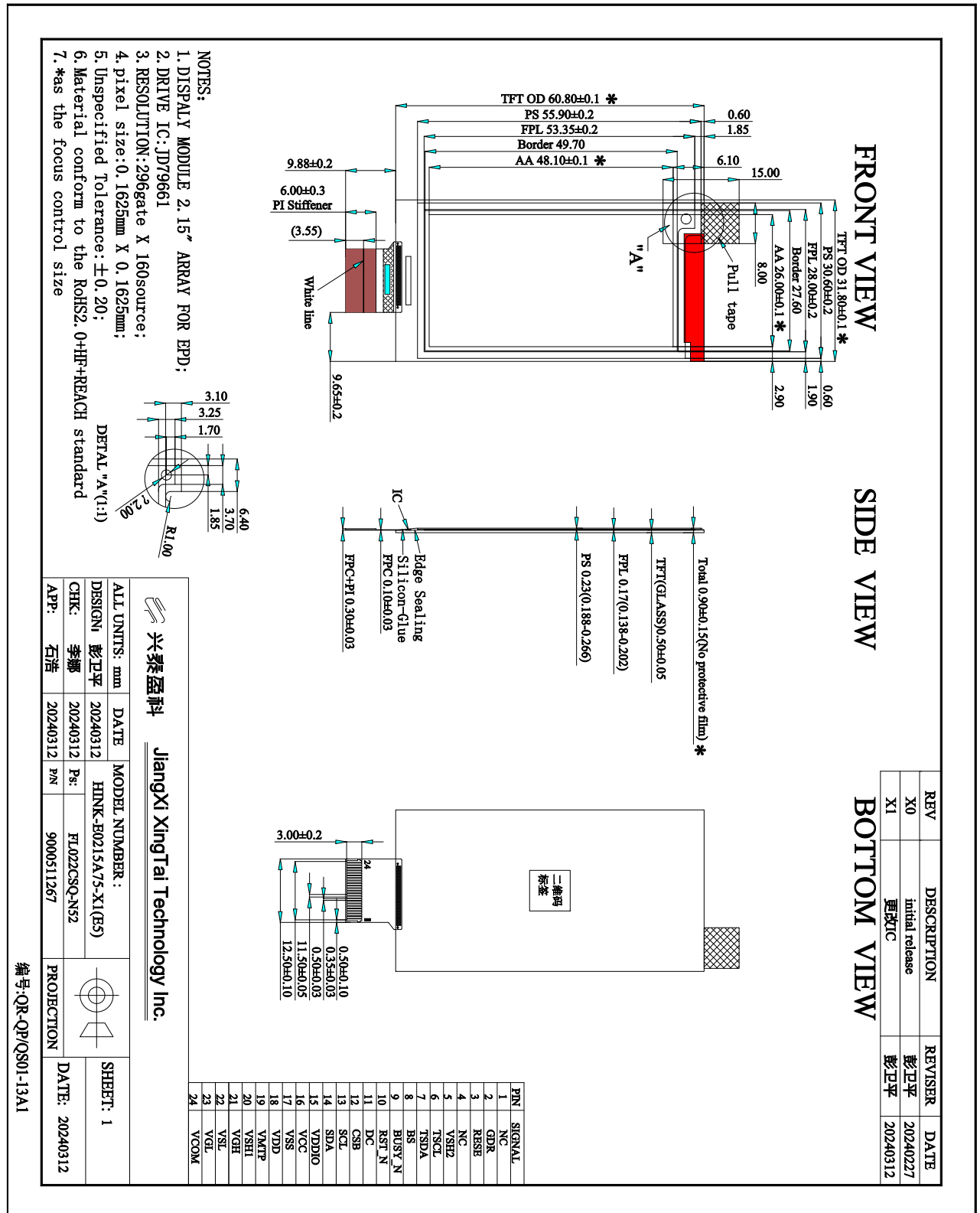
4. Mechanical Specifications

Parameter	Specifications	Unit	Remark
Screen Size	2.15	Inch	
Display Resolution	160(H)×296(V)	Pixel	Dpi:156
Active Area	26.00 (H)×48.10 (V)	mm	
Pixel Pitch	0.1625×0.1625	mm	
Pixel Configuration	Square		
Outline Dimension	31.80(H)×60.80(V) ×0.9(D)	mm	
Weight	3.0±0.2	g	



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5. Mechanical Drawing of EPD module





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6. Input/output Terminals

Pin #	Single	Description	Remark
1	NC	No connection and do not connect with other NC pins	Keep Open
2	GDR	N-Channel MOSFET Gate Drive Control	
3	RESE	Current Sense Input for the Control Loop	
4	NC	No connection and do not connect with other NC pins	Keep Open
5	VSH2	Positive Source driving voltage	
6	TSCL	I ² C Interface to digital temperature sensor Clock pin, Must pull high or low if not used	
7	TSDA	I ² C Interface to digital temperature sensor Clock pin, Must pull high or low if not used	
8	BS1	Bus selection pin	Note 6-5
9	BUSY	Busy state output pin	Note 6-4
10	RES #	Reset signal input.	Note 6-3
11	D/C #	Data /Command control pin	Note 6-2
12	CS #	The chip select input connecting to the MCU.	Note 6-1
13	SCL	Serial clock pin for interface.	
14	SDA	Serial data pin for interface.	
15	VDDIO	Power input pin for the Interface.	
16	VCI	Power Supply pin for the chip	
17	VSS	Ground (Digital)	
18	VDD	Core logic power pin	
19	VPP	Power Supply for OTP Programming	
20	VSH1	Positive Source driving voltage	
21	VGH	Power Supply pin for Positive Gate driving voltage	
22	VSL	Negative Source driving voltage	
23	VGL	Power Supply pin for Negative Gate driving voltage	
24	VCOM	VCOM driving voltage	

Note 6-1: This pin (CS#) is the chip select input connecting to the MCU. The chip is enabled for MCU communication: only when CS# is pulled LOW.

Note 6-2: This pin (D/C#) is Data/Command control pin connecting to the MCU.

When the pin is pulled HIGH, the data will be interpreted as data. When the pin is



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pulled LOW, the data will be interpreted as command.

Note 6-3: This pin (RES#) is reset signal input. The Reset is active low.

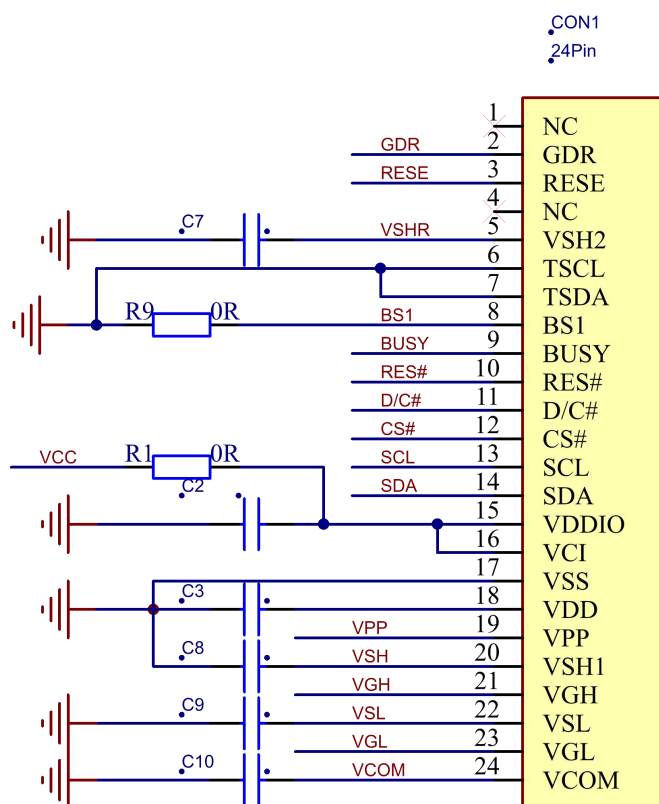
Note 6-4: This pin (BUSY) is Busy state output pin. When Busy is Low, the operation of chip should not be interrupted and any commands should not be issued to the module. The driver IC will put Busy pin Low when the driver IC is working such as:

- Outputting display waveform; or
- Communicating with digital temperature sensor

Note 6-5: This pin (BS1) is for 3-line SPI or 4-line SPI selection. When it is "Low", 4-line SPI is selected. When it is "High", 3-line SPI (9 bits SPI) is selected.

7. Reference Circuit

Figure. 7-1





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Figure. 7-2

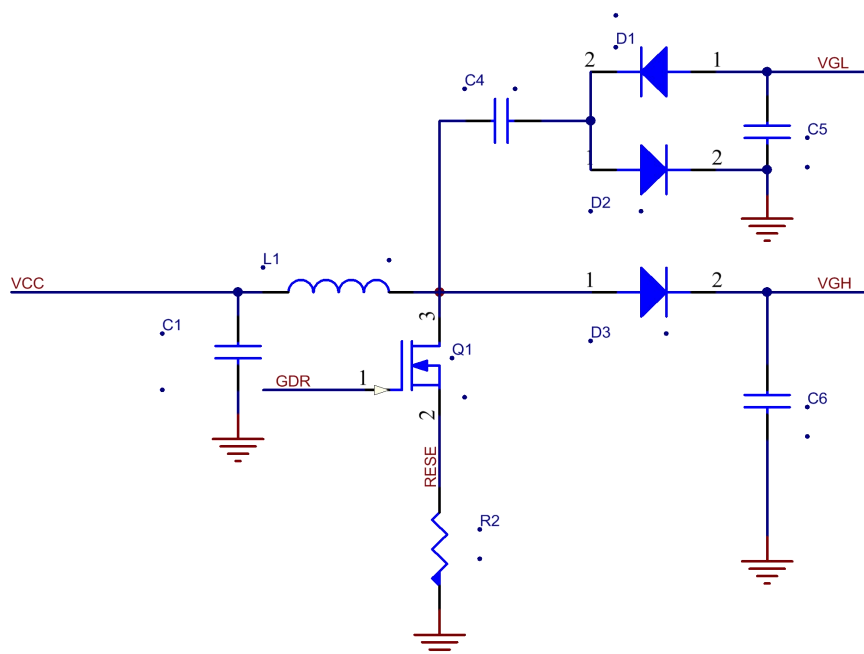


Table. 7-3

Part Name	Value /requirement/Reference Part
C1—C9	1uF/0603;X5R;Voltage Rating: 25V
C10	1uF/0603;X7R;Voltage Rating: 25V
D1—D3	MBR0530 1) Reverse DC voltage $\geq 30V$ 2) Forward current $\geq 500mA$ 3) Forward voltage $\leq 430mV$
R2	2.2 Ω /0603: 1% variation
Q1	NMOS:Si1304BDL/NX3008NBK 1) Drain-Source breakdown voltage $\geq 30V$ 2) $V_{gs(th)} = 0.9 (Typ), 1.3V (Max)$ 3) $R_{ds(on)} \leq 2.1\Omega @ V_{gs}=2.5V$
L1	47uH/NRH3010T470MN Maximum DC current $\sim 420mA$ Maximum DC resistance $\sim 650m\Omega$
CON24Pin	0.5mm ZIF Socket 24Pins,0.5mm pitch



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8. ABSOLUTE MAXIMUM RATING

Parameter	Symbol	Rating	Unit	Humidity	Unit	Note
Logic Supply voltage	VCC,VDDIO	-0.3~6.0	V	45~70	%RH	Note 8-1
Operation temperature range	TOPR	0~40	°C	45~70	%RH	
Storage temperature range	TSTG	0~30	°C	45~70	%RH	Note 8-2
Transportation temperature range	TTTG	-25~50	°C	45~70	%RH	Note 8-3
GND	Ground	-	-		-	Connect to Ground

Note 8-1: Maximum ratings are those values beyond which damages to the device may occur. VCC: Digital power, VDDIO: IO power. Functional operation should be restricted to the limits in the Electrical Characteristics chapter.

Note 8-2: The display effect may be affected if the product is stored for more than 10days under the environment of 40-50 degree.

Note 8-3: TTTG is the transportation condition, the transport time is within 10 days for -25°C~0°C or 40°C~50°C

Note 8-4: The single pixel effect under the condition of above 35 degree cannot be guaranteed. Normal use is recommended to refresh every 24 hours

Note 8-5: Due to the nature of FPL, we will not control the display effect of white characters on yellow and yellow characters on white.

9. DC Characteristics

The following specifications apply for: VSS=0V, VCC=3.0V, TOPR=25±2°C.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
VDD	VDD operation voltage	-	2.3	3.0	3.6	V
VIH	High level input voltage	-	0.7xVIO	-	VIO	V
VIL	Low level input voltage	-	GND	-	0.3xVDD	V
VOH	High level output voltage	IOH = 400μA	VIO-0.4	-	-	V
VOL	Low level output voltage	IOL = -400μA	GND	-	GND+0.4	V
Iupdate	Module operating current	-	-	3	-	mA
Isleep	Deep sleep mode	VCI=3.3V	-	-	3	uA

- The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by XingTai.

- VCOM value will be OTP before in factory.

10. Power Consumption

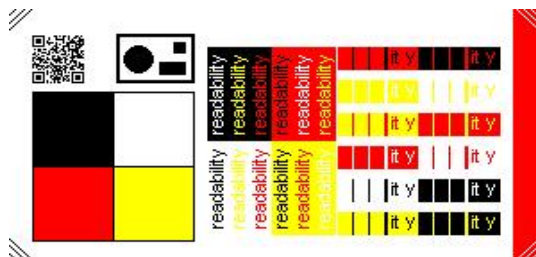
Parameter	Symbol	Conditions	TYP	Max	Unit	Remark
Panel power consumption during update	-	25°C	-	70	mAs	-

MAs=update Average current ×update time

The power consumption is measured using associated 25°C waveform with following pattern transition:



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11. Optical characteristics

11.1 Optical Measurement Conditions

Item	Symbol	Value	Unit	Note
Ambient Temperature	Ta	25±2	°C	Indoor testing
Ambient Humidity	Ha	50±5	%RH	-
Supply Voltage	VCC, VDDIO	3.0	V	-
illuminance	-	800~1300	Lux	

Note 11-1: Image is updated with above condition

11.2 Optical Measurement

VDD=3.3V

Temperature (°C)		0≤T≤5℃	5 < T≤11℃	11 < T≤20℃	20 < T≤30℃	30 < T≤40℃
white state	TYP L*	65	65	65	65	65
	MIN L*	60	60	60	59.5	58
	a*	—	—	—	—	—
	b*	≤2.5	≤2.5	≤2.5	≤2.5	≤2.5
black state	TYP L*	9	9	9	9	9
	MAX L*	14	14	14	14	14
	a*	≤7	≤7	≤7	≤7	≤7
	a* (15A1B)	≤8	≤8	≤8	≤8	≤8
red state	MAX L*	28	28	28	28	28
	TYP L*	25	25	26	26	26
	MIN L*	23	23	24	24	24
	TYP a*	37	38	38	40	40
	MIN a*	34	35	36	38	38
	b*	≤34	≤34	≤34	≤35	≤35
yellow state	MAX L*	60	60	60	62	62
	TYP L*	55	56	57	58	58
	MIN L*	52	52	52	54	54
	TYP b*	60	62	64	68	68
	MIN b*	54	54	56	60	60
	a*	≤18	≤18	≤18	≤18	≤18
T24H Ghosting (15A1B) △E2000		≤2	≤2	≤2	≤2	≤2



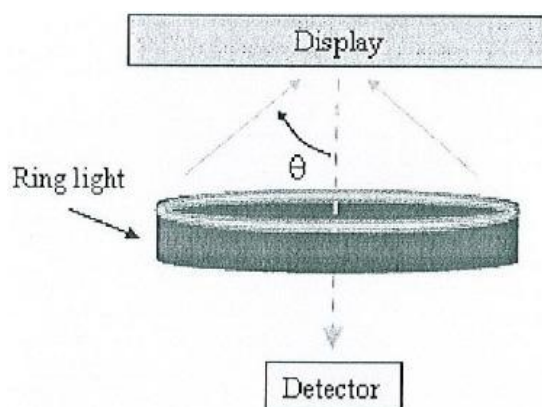
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Remarks:

1. Test instrument: i-one (D50 light source 2 ° viewing angle)
2. All optical data are test values in T0 state; (T0 is the status of the first EPD refresh test);
3. Chosting judges based on optical data, not visual standards; Calculate formula ΔE_{2000} ;

11.3 Definition of contrast ratio

The contrast ratio (CR) is the ratio between the reflectance in a full white area (Rl) and the reflectance in a dark area (Rd): Rl: white reflectance Rd: dark reflectance
$$CR = R_l / R_d$$

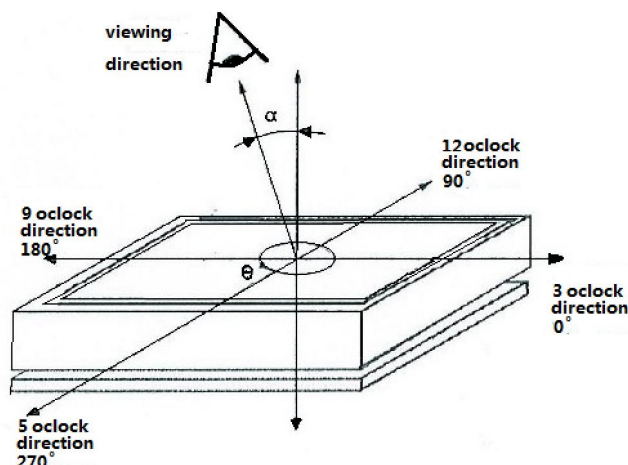


11.4 Reflection Ratio

The reflection ratio is expressed as:

$R = \text{Reflectance Factor white board} \times (L_{\text{center}} / L_{\text{white board}})$

L center is the luminance measured at center in a white area (R=G=B=1). L white board is the luminance of a standard white board. Both are measured with equivalent illumination source. The viewing angle shall be no more than 2 degrees.





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12. Handling Safety and Environmental Requirements

WARNING

The display module should be kept flat or fixed to a rigid, curved support with limited bending along the long axis. It should not be used for continual flexing and bending. Handle with care. Should the display break do not touch any material that leaks out. In case of contact with the leaked material then wash with water and soap.

CAUTION

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components.

Disassembling the display module can cause permanent damage and invalidate the warranty agreements.

IPA solvent can only be applied on active area and the back of a glass. For the rest part, it is not allowed.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricity and other rough environmental conditions.

Mounting Precautions

(1) It's recommended that you consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module.

(2) It's recommended that you attach a transparent protective plate to the surface in order to protect the EPD. Transparent protective plate should have sufficient strength in order to resist external force.

(3) You should adopt radiation structure to satisfy the temperature specification.

(4) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the PS at high temperature and the latter causes circuit break by electro-chemical reaction.

(5) Do not touch, push or rub the exposed PS with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of PS for bare hand or greasy cloth. (Some cosmetics deteriorate the PS)

(6) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach the PS. Do not use acetone, toluene and alcohol because they cause chemical damage to the PS.

(7) Wipe off saliva or water drops as soon as possible. Their long time contact with PS causes deformations and color fading.



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Data sheet status	
Product specification	The data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
Product Environmental certification	
ROHS	
REMARK	
All The specifications listed in this document are guaranteed for module only. Post-assembled operation or component(s) may impact module performance or cause unexpected effect or damage and therefore listed specifications is not warranted after any Post-assembled operation.	



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13. Reliability test

13.1 Reliability test items

	TEST	CONDITION	METHOD	QUANTITY	JUDGMENT	REMARK
1	High-Temperature Operation	T=40°C, RH=35%RH, For 240Hr		5pcs	PASS	
2	Low-Temperature Operation	T = 0°C for 240 hrs		5pcs	PASS	
3	High-Temperature Storage	T=50°C RH=35%RH For 240Hr Test in white pattern		5pcs	PASS	
4	Low-Temperature Storage	T = -25°C for 240 hrs Test in white pattern		5pcs	PASS	
5	High Temperature, High-Humidity Operation	T=40°C, RH=90%RH, For 168Hr		5pcs	PASS	
6	High Temperature, High-Humidity Storage	T=50°C, RH=90%RH, For 240Hr Test in white pattern		5pcs	PASS	
7	Temperature Cycle	-25°C(30min)~60°C(30min), 50 Cycle Test in white pattern		5pcs	PASS	
8	Package Vibration	1.04G, Frequency : 10~500Hz Direction : X,Y,Z Duration: 1hours in each direction	Full packed for shipment	1box	PASS	
9	Package Drop Impact	Drop from height of 100 cm on Concrete surface Drop sequence: 1 corner, 3 edges, 6 face One drop for each.	Full packed for shipment	1box	PASS	
10	UV exposure Resistance	765 W/m ² for 168hrs, 40°C		5pcs	PASS	
11	ESD test	Machine model: +/-250V, 0Ω, 200pF		5pcs	PASS	

Actual EMC level to be measured on customer application.

Note1: Stay white pattern for storage and non-operation test.

Note2: Power off duration time is 30s

Note3: Continue testing after 2 hours at 20C~25C°C

13.2 Product life time

The EPD Module is designed for a 5-year life-time with 25 °C/60%RH operation assumption. Reliability estimation testing with accelerated life-time theory would be demonstrated to provide confidence of EPD lifetime.

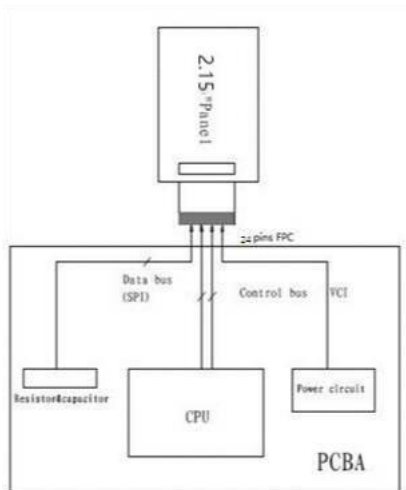
13.3 Product warranty

Warranty conditions have to be negotiated between Xingtai and individual customers. Xingtai provides 24(one month delivery time) months warranty for all products which are purchased from Xingtai.



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14. Block Diagram



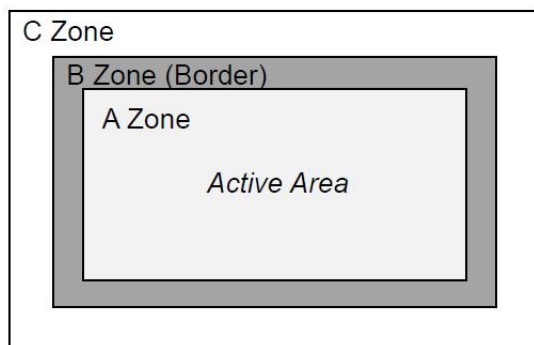
15. Shipment inspection specification

15.1 Zone Definition

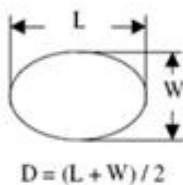
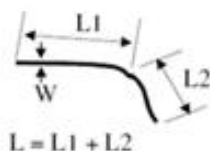
A Zone: Active Area

B Zone: Border Area

C Zone: From B Zone edge to panel edge



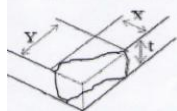
15.2 Line/Spot defect size





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15.3 Point and line standard

Shipment Inspection Standard						
Equipment: Electrical test fixture, Point gauge						
Outline dimension	31.80(H)×60.80(V)×0.9(D)	Unit: mm	Part-A	Active area	Part-B	Border area
Environment	Temperature	Humidity	illuminance	Distance	Angle	
	23±5℃	40 ~ 70%RH	1000~1300Lux	30±10Cm	45°	
Defect type	Inspection method	Standard		Part-A	Part-B	
Spot	Electric Display	D≤0.25 mm		Ignore	Ignore	
		0.25 mm<D≤0.4 mm		N≤4	Ignore	
		D>0.4 mm		Not Allow	Ignore	
Display malfunction	Electric Display	Not Allow		Not Allow	Ignore	
Display error	Electric Display	Not Allow		Not Allow	Ignore	
Scratch or line defect(include dirt)	Visual/Film card	L≤2 mm,W≤0.2 mm		Ignore	Ignore	
		2.0mm<L≤5.0mm, 0.2<W≤0.3mm,		N≤2	Ignore	
		L>5 mm,W>0.3 mm		Not Allow	Ignore	
PS Bubble	Visual/Film card	D≤0.2mm		Ignore	Ignore	
		0.2mm≤D≤0.35mm		N≤4	Ignore	
		D>0.35 mm		Not Allow	Ignore	
Corner /Edge chipping	Visual/Film card	X≤6mm,Y≤0.4mm, Do not affect the electrode circuit (Edge chipping)				
		X≤1mm,Y≤1mm, Do not affect the electrode circuit((Corner chipping)				
		Ignore				
						
TFT warping	For 1.54~7.5inch, T≤2mm; For above 7.5inch, T≤3mm					
Remark	1.Cannot be defect & failure cause by appearance defect;					
	2.Cannot be larger size cause by appearance defect;					
	L=long W=wide D=point size N=Defects NO					



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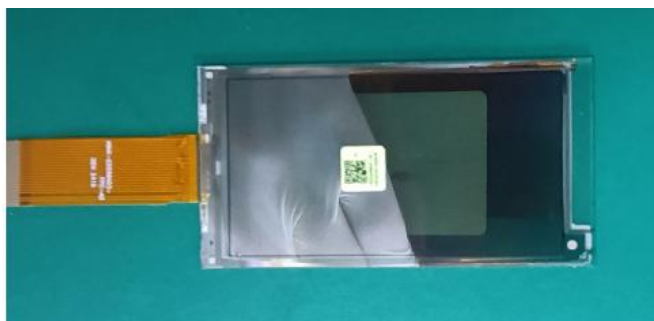
15.4 Barcode



What is the QR code after picture being scanned and read? It consist of 30 numbers and letters, here is explanation for it.

QR Code: ABBBBBBBBBBFFCCCDDDEEEEGHIJKLL

- ① A means Factory code, e.g.: "H" stands for Jiangxi Xingtai Technology Co., Ltd. old factory, "S" stands for Jiangxi Xingtai Technology Co., Ltd. new factory, "V" stands for Jiangxi Xingtai Technology Co., Ltd. Vietnam factory.
- ② BBBBBBBBBB refers to product model name, which is in consistent with specification part number. E.g.: E0213A189 or E0266A120; when the total code is less than 9, it would be added suffix with **. e.g.: E027A45** or E0154A78*
- ③ FF means production workshop
- ④ CCC means date of production
- ⑤ DDD means production batch
- ⑥ EEEE means FPL lot
- ⑦ G means MP/Sample/Trial/Repair
- ⑧ HIJ:(H——TFT;I——PS;J——EC Glue)
- ⑨ KK means IC type
- ⑩ LL means serial number



	Jiangxi factory	Vietnam factory
Label color	White	Green
Model description	Start with "H"	Start with "V"

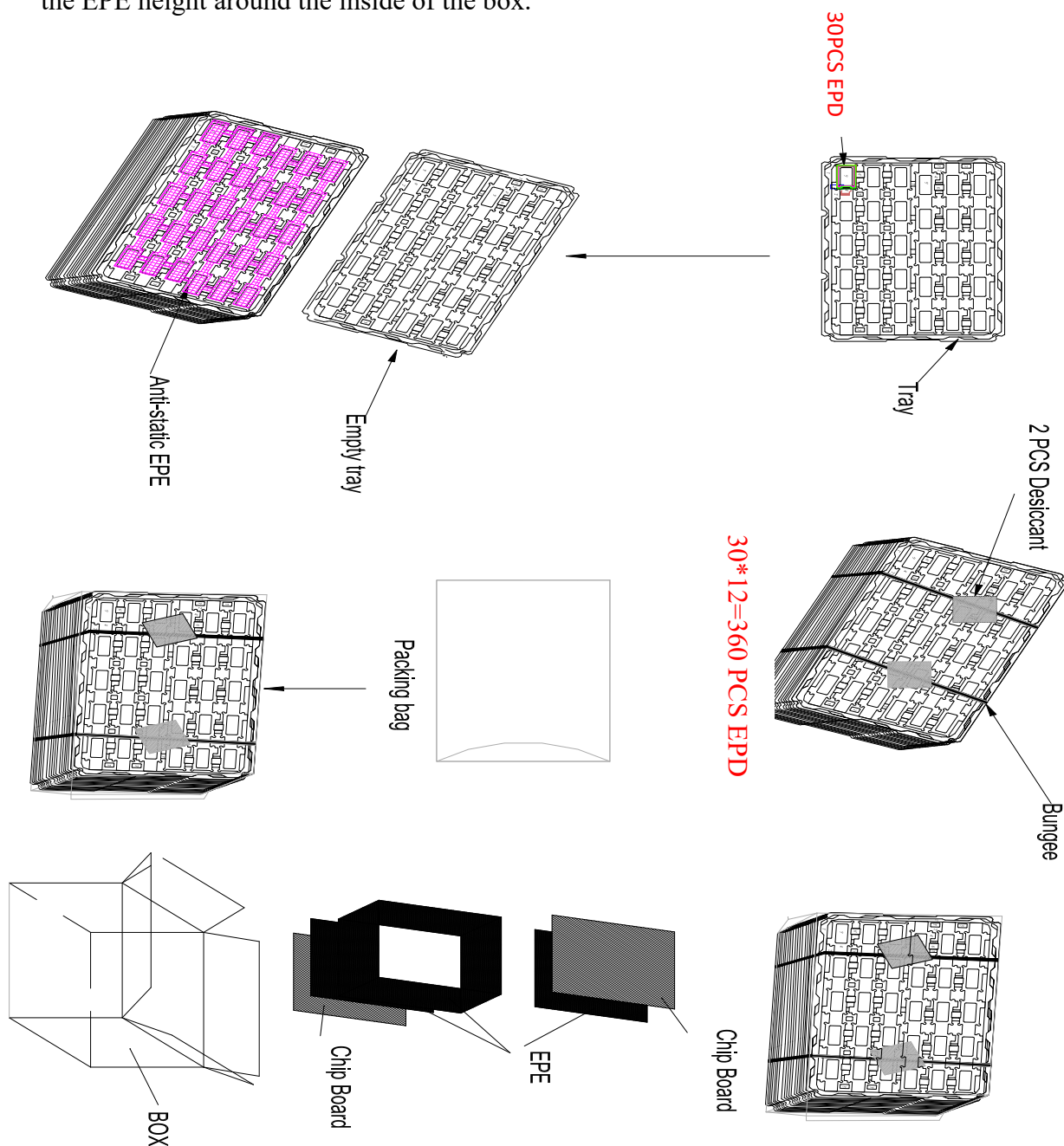


File Name	Specification For 2.15" EPD	Module Number	HINK-E0215A75
Version	A2	Page Number	18 of 18

16. Packing

Full carton: 12 pcs tray with products and 1 pcs empty tray.

Last carton: less 12pcs tray with products and 1 pcs empty tray. The packager will add the right amount of EPE to box so that the added EPE's height approximately close to the EPE height around the inside of the box.





XingTai Vietnam Factory RA Report of 2.15 N52+79661CA

SEEKINK TECHNOLOGY (VN).

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Qualification result of reliability test

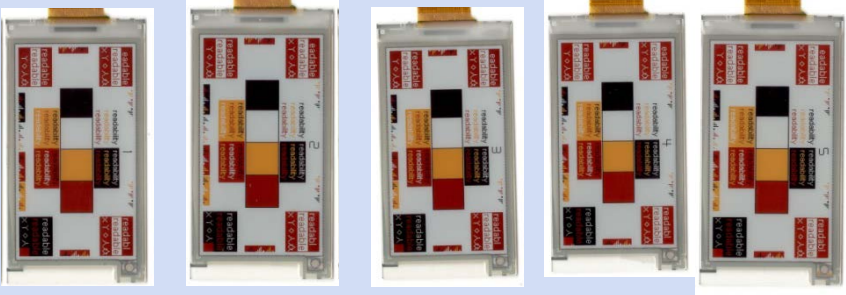
❑ Total 9 reliability items were scheduled (5pcs EPD per reliability item), and all test will be completed on 27th Feb.

No	Experimental Item	Experimental Condition
1	High Temperature storage Test	T 50°C/35%RH 500Hrs
2	High Temperature& Humidity storage Test	T 50°C 90%RH 500Hrs
3	Low Temperature storage test	T=0°C, 500Hrs
4	High Temperature& Humidity Operation Test	T=40°C90%RH, 150S 500Hrs
5	Low Temperature Operation Test	T=0°C, 150S 500Hrs
6	High Temperature Operation Test	T=40°C35%RH, 150S 500Hrs
7	Thermal Shock Test	-25°C(30min)~60°C(30min), 100Cycle(30min), Test in white pattern
8	UV exposure	765W/m ² for 168hrs,40°C
9	ESD test	Machine model: +/-250V,0Ω,200pF

1、High Temperature storage Test T 50°C 35%RH 500H

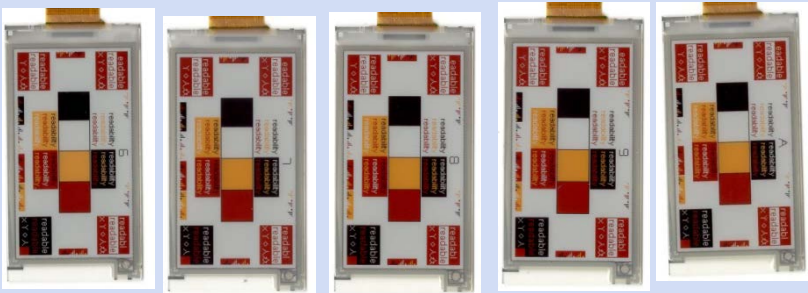
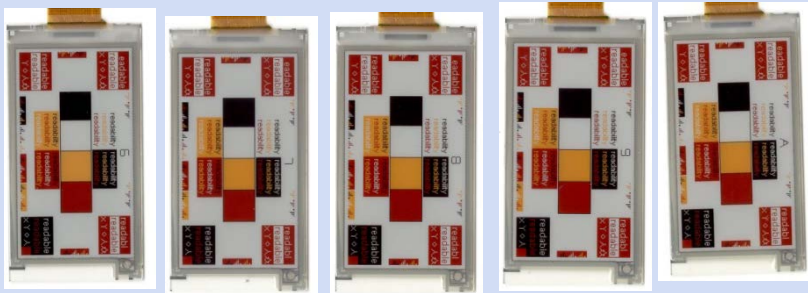


Time (hrs)	0H	120H	240H	360H	500H
Test result	OK	OK	OK	OK	OK

model	0H	500H	Remark
2.15			OK

2、High Temperature& Humidity storageTest T50℃ 90%RH 500H

Time (hrs)	0H	120H	240H	360H	500H
Test result	OK	OK	OK	OK	OK

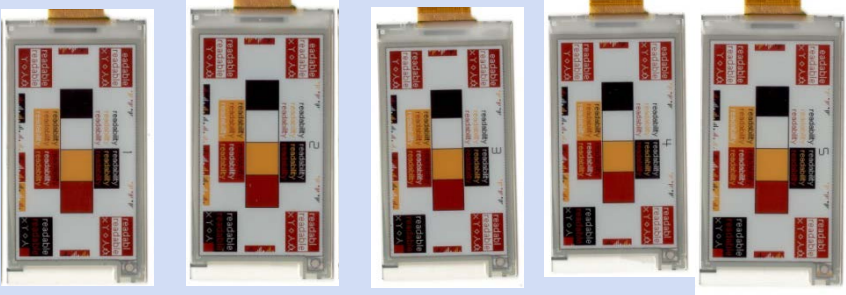
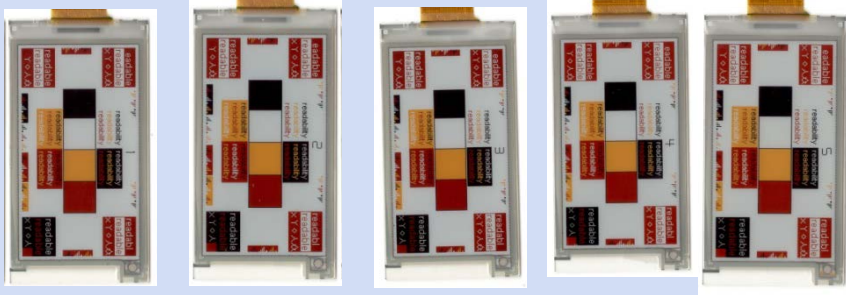
model	0H	500H	Remark
2.15			OK

3、Low Temperature storage test

T -25°C 500H



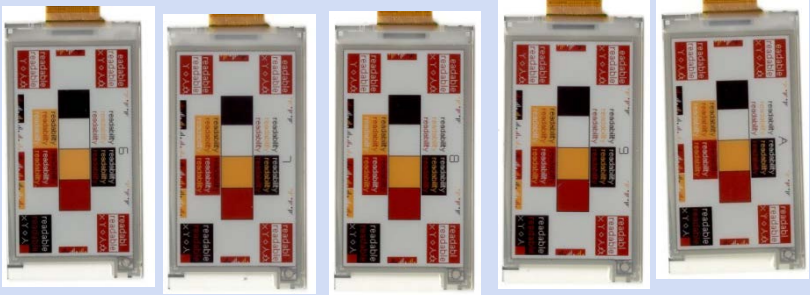
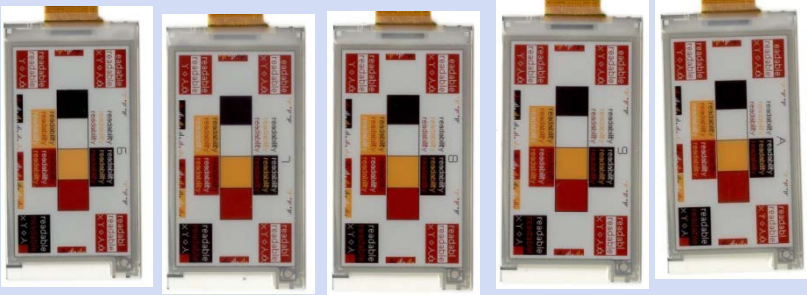
Time (hrs)	0H	120H	240H	360H	500H
Test result	OK	OK	OK	OK	OK

model	0H	500H	Remark
2.15			OK

4、 High Temperature& Humidity Operation Test T 40°C 90%RH

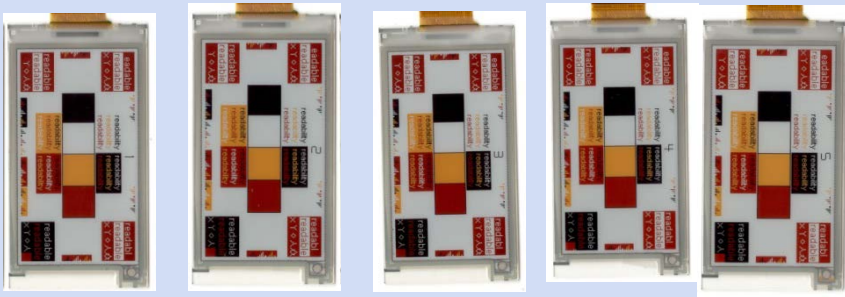
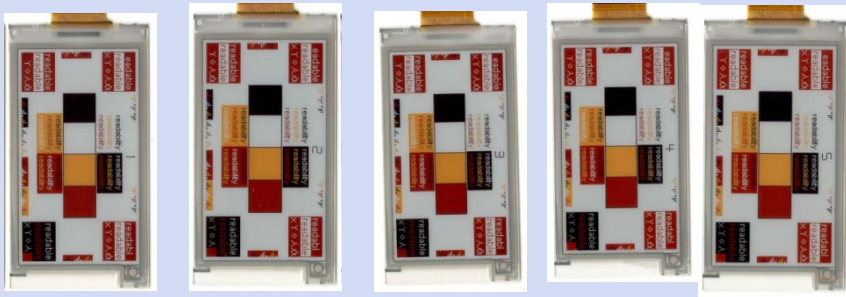


Time (hrs)	0H	120H	240H	360H	500H
Test result	OK	OK	OK	OK	OK

model	0H	500H	Remark
2.15			OK

5、 Low Temperature operation Test T 0°C 150S 500H

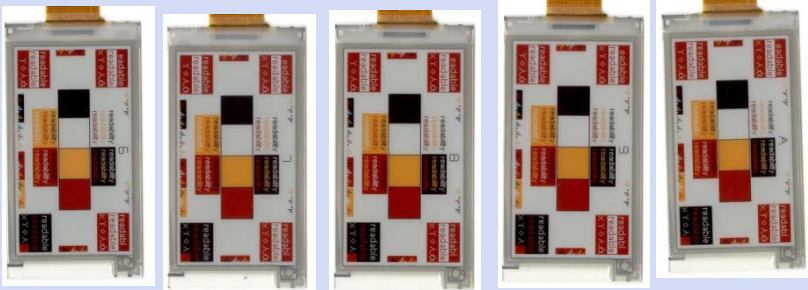
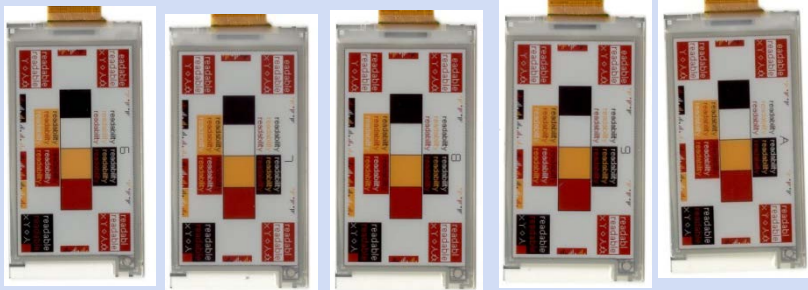


	Time (hrs)	0H	120H	240H	360H	500H
	Test result	OK	OK	OK	OK	OK
model	0H			500H		Remark
2.15						OK

6、High Temperature operation Test T40℃ 35%RH 150S 500H



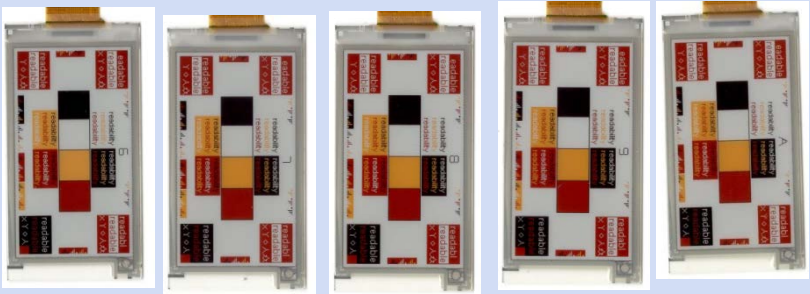
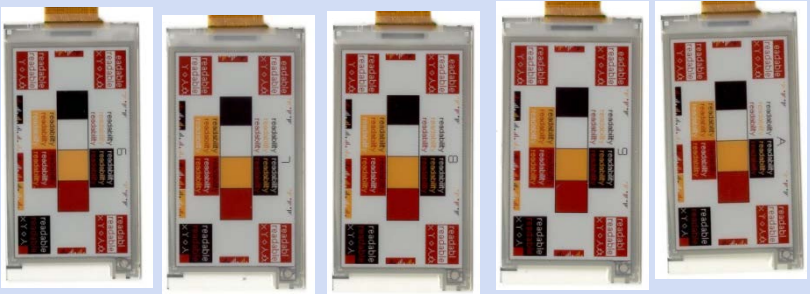
Time (hrs)	0H	120H	240H	360H	500H
Test result	OK	OK	OK	OK	OK

model	0H	500H	Remark
2.15			OK

7、 Thermal shock TestT-25℃ (min) 60℃ (30min) 100Cycle

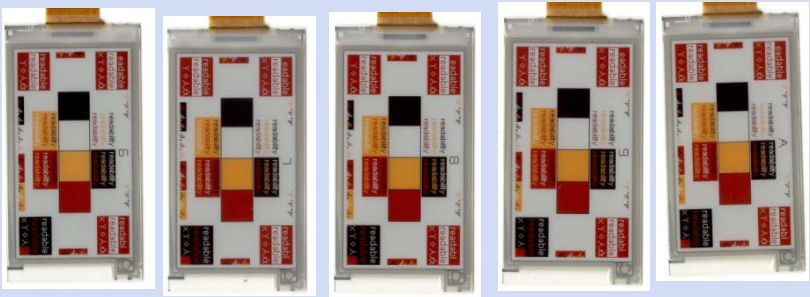
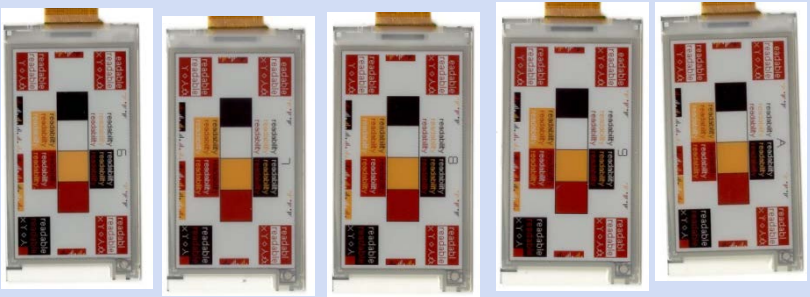


Time (hrs)	0H	100H
Test result	OK	OK

model	0H	500H	Remark
2.15			OK

8、Solar radiation 765KW/m² for 168hrs,40°C

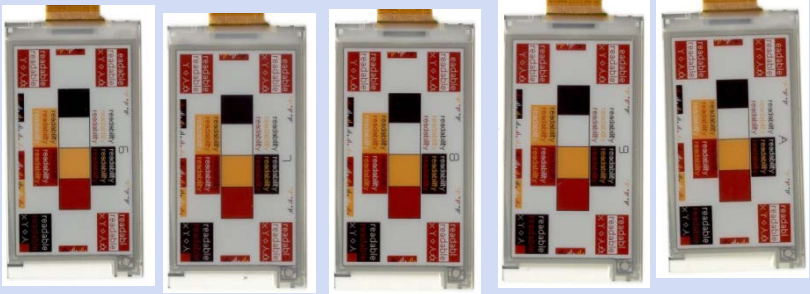
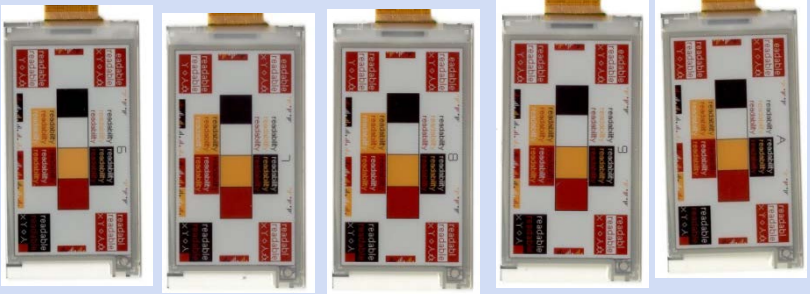
Time (hrs)	0H	168H
Test result	OK	OK

model	0H	500H	Remark
2.15			OK

9、ESD test



Time (hrs)	0H	24H
Test result	OK	OK

model	0H	500H	Remark
2.15			OK



谢谢观看

THANKS FOR WATCHING

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作业指导书 (SOP)

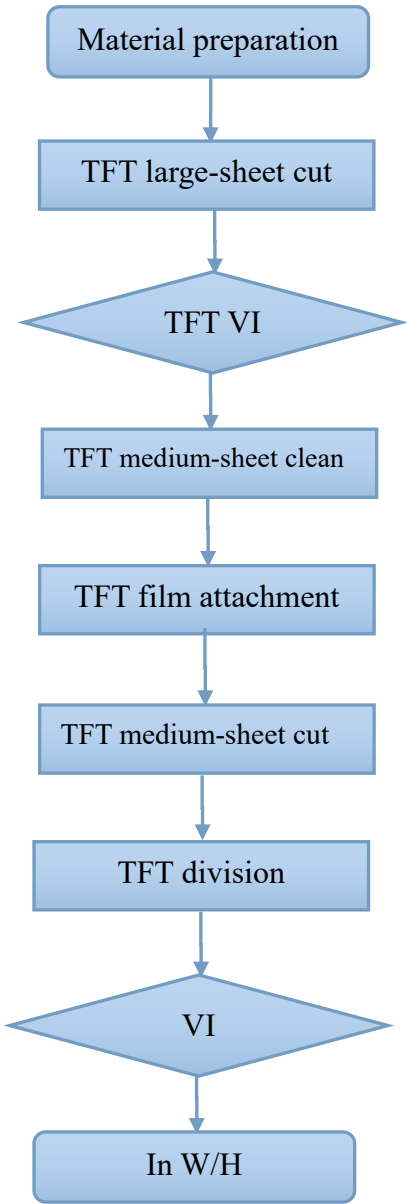
	编制	工程处	设备处	制程处	制造处	核准	
江西兴泰科技股份有限公司		安全性 / 品质 SAFETY/QUALITY		工具 / 设备 / 耗材 TOOLS/EQUIPMENT/SUPPLIES		生效日期 DATE	2023 年 11 月 13 日
工 段 SECTION	HINK whole procedures	1. 正确穿着无尘服 2. 正确佩带静电环 3. 未通过认证禁止操作	4. 轻拿轻放产品 5. 认真遵守规则 6. 及时反馈问题			最新版次 VER.	A2
作业名称 OPERATION	E5 Full automatic production line Flow chart for UV glue					文件编号 FILE. NO.	WI-PE (HINK)-398

作业步骤及图示 OPERATION DESCRIPTION AND FIGURES

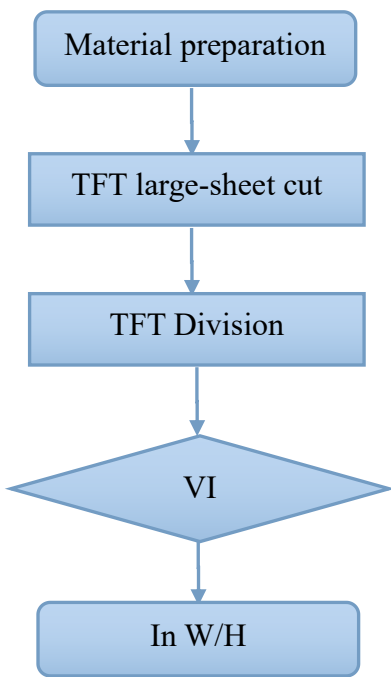
Material Preparation procedure:

TFT Division +FPL Division +PS Division

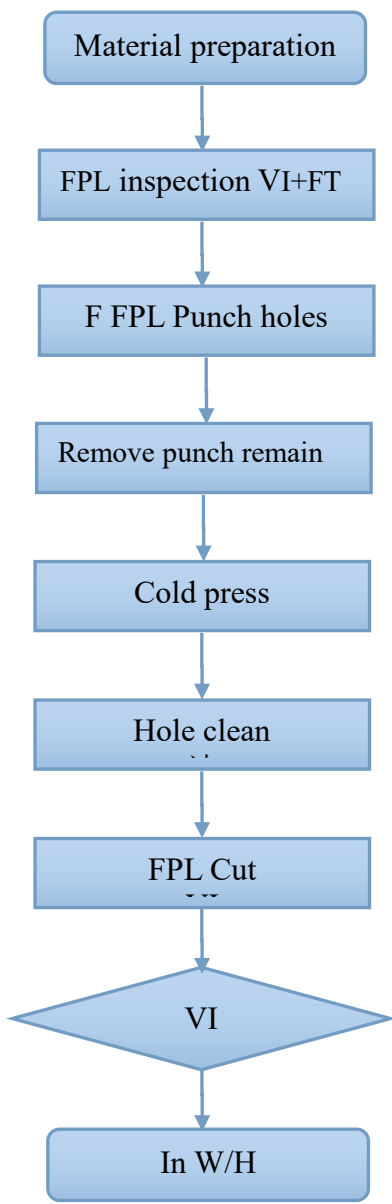
TFT Division (without film)



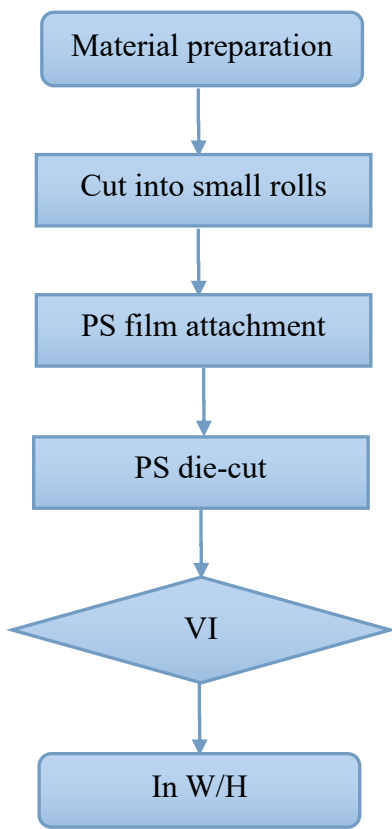
TFT(with film)



FPL Cut



PS Die-Cut



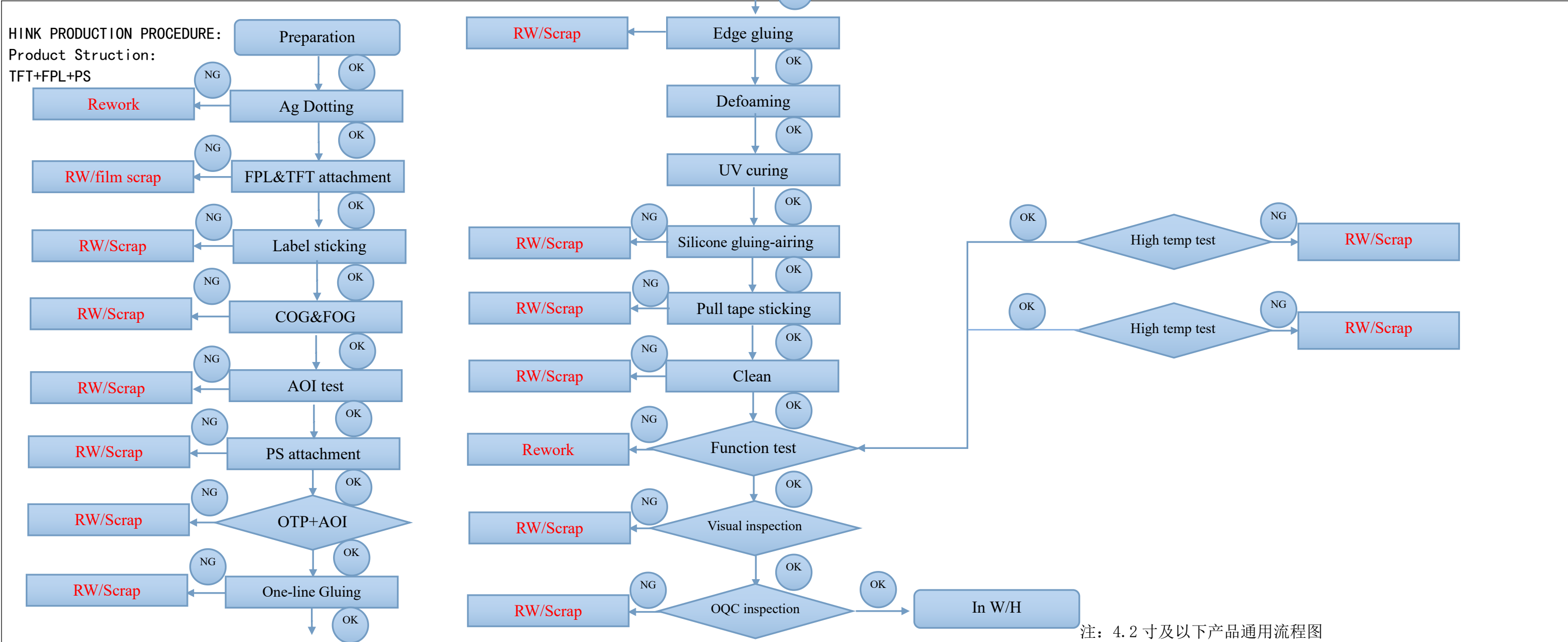
共同遵守事项: 1. 请自觉实施顺次检查方法! 2. 后一站检查前一站的作业是否完全, 确认到位, 如发现不良情况要及时反馈

作业指导书 (SOP)



编制	工程处	设备处	制程处	制造处	核准

江西兴泰科技股份有限公司		安全性 / 品质 SAFETY/QUALITY		工具 / 设备 / 耗材 TOOLS/EQUIPMENT/SUPPLIES	生效日期 DATE	2023 年 11 月 13 日
工 段 SECTION	HINK whole procedures	1. 正确穿着无尘服 2. 正确佩带静电环 3. 未通过认证禁止操作	4. 轻拿轻放产品 5. 认真遵守规则 6. 及时反馈问题		最新版次 VER.	A2
作业名称 OPERATION	E5 Full automatic production line Flow chart for UV glue				文件编号 FILE. NO.	WI-PE (HINK)-398



注：4.2 寸及以下产品通用流程图

品质注意事项 QUALITY ITEM	前一版次 VER.	变更原因 REASON OF CHANGE	变更内容 REVISION	修改时间 DATE
1. 爱护产品，轻拿轻放 2. 有疑问请立即通知班长/IPQC 及相关工艺.	无	新增文件	整版	2023. 11. 11

共同遵守事项： 1. 请自觉实施顺次检查方法！ 2. 后一站检查前一站的作业是否完全，确认到位，如发现不良情况要及时反馈